TOSHIBA 2SC5066FT

TOSHIBA TRANSISTOR SILICON NPN EPITAXIAL PLANAR TYPE

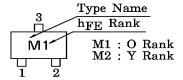
VHF~UHF BAND LOW NOISE AMPLIFIER APPLICATIONS

- Low Noise Figure, High Gain.
- $NF = 1.1dB, |S_{21e}|^2 = 12dB (f = 1GHz)$

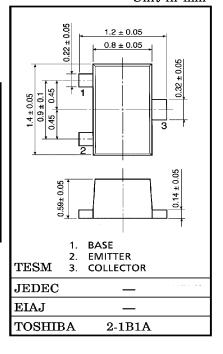
## MAXIMUM RATINGS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	RATING	UNIT
Collector-Base Voltage	$V_{CBO}$	20	V
Collector-Emitter Voltage	$v_{CEO}$	12	V
Emitter-Base Voltage	$v_{\mathrm{EBO}}$	3	V
Base Current	$I_{\mathbf{B}}$	15	mA
Collector Current	$I_{\mathbf{C}}$	30	mA
Collector Power Dissipation	$P_{\mathbf{C}}$	100	mW
Junction Temperature	$T_{j}$	125	°C
Storage Temperature Range	$\mathrm{T_{stg}}$	-55~125	°C

### MARKING



# Unit in mm



# MICROWAVE CHARACTERISTICS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Transition Frequency	${ m f_T}$	$V_{CE}=5V, I_{C}=10mA$	5	7	_	GHz
Insertion (fain	$ S_{21e} ^2(1)$	$V_{CE} = 5V, I_{C} = 10mA, f = 500MHz$	_	17	_	dB
	$ S_{21e} ^2(2)$	$V_{CE}=5V$ , $I_{C}=10$ mA, $f=1$ GHz	8.5	12	_	
INoise Figure	NF (1)	$V_{CE}=5V$ , $I_{C}=3mA$ , $f=500MHz$	_	1	_	I.D.
	NF (2)	$V_{CE}=5V$ , $I_{C}=3mA$ , $f=1GHz$	_	1.1	2.0	dB

## ELECTRICAL CHARACTERISTICS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Collector Cut-off Current	$I_{\mathrm{CBO}}$	$V_{CB} = 10V, I_{E} = 0$	_	_	1	$\mu$ A
Emitter Cut-off Current	$I_{ m EBO}$	$V_{EB}=1V, I_{C}=0$	_	_	1	$\mu$ A
DC Current Gain	h <sub>FE</sub> (Note 1)	$V_{\rm CE}$ =5V, $I_{\rm C}$ =10mA	80	_	240	<u> </u>
Output Capacitance	$C_{ m ob}$	$V_{CB}=5V$ , $I_E=0$ , $f=1MHz$	_	0.7	_	рF
Reverse Transfer Capacitance	$\mathrm{c_{re}}$	(Note 2)	_	0.45	0.9	рF

(Note 1): hFE Classification O:80~160, Y:120~240

(Note 2): Cre is measured by 3 terminal method with capacitance bridge.

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1998-08-04